

MX27L4000

4M-BIT [512K x8] LOW VOLTAGE OPERATION CMOS EPROM

FEATURES

- 512K x 8 organization
- Wide voltage range, 2.7V to 3.6V
- +12.5V programming voltage
- Fast access time: 200/250ns
- · Totally static operation
- Completely TTL compatible

- Operating current: 20mA @ 3.6V, 5MHz
- Standby current: 50uA
- Package type:
 - 32 pin plastic DIP
 - 32 pin PLCC/SOP
 - 32pin TSOP

GENERAL DESCRIPTION

The MX27L4000 is a 4M-bit, One Time Programmable Read Only Memory. It is organized as 512K words by 8 bits per word, operates from a single +3 volt supply, has a static standby mode, and features fast single address location programming. All programming signals are TTL levels, requiring a single pulse. For programming outside from the system, existing EPROM programmers

may be used. The MX27L4000 supports a intelligent fast programming algorithm which can result in programming time of less than two minutes.

This EPROM is packaged in industry standard 32 pin dual-in-line packages, 32 lead PLCC, 32 lead SOP, and 32 lead TSOP(I) packages.

PIN CONFIGURATIONS

32 PDIP/SOP

VPP □ 1

A16 🗆 2

A15 🖂 3

A12 🗖 4

A7 🗆 5

A6 □ 6

A5 🗖 7

A3 🗆 9

A2 🗖 10

A0 🗖 12

Q0 🗖 13

Q2 🗖 15

GND 🗖 16

A4 □ 8

A1 🗖 11

Q1 🗖 14

□ A9

☐ A10

22 H CF

□ Q6

¬ Q5

_ Q3

32

31 🗖 A18

30 🗖 A17

29 A A14

28 🗆 A13

27 🗆 A8

26

25 🗆 A11

24 🗆 ŌE

23

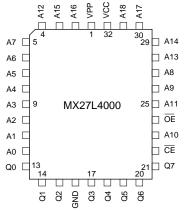
21 🗖 Q7

20

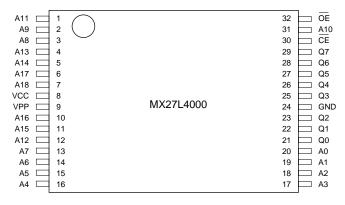
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18 🗖 Q4

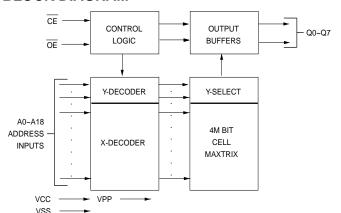
32 PLCC



32TSOP



BLOCK DIAGRAM



PIN DESCRIPTION

SYMBOL	PIN NAME
A0~A18	Address Input
Q0~Q7	Data Input/Output
CE	Chip Enable Input
ŌĒ	Output Enable Input
VPP	Program Supply Voltage
VCC	Power Supply Pin
GND	Ground Pin
	·



FUNCTIONAL DESCRIPTION

THE PROGRAMMING OF THE MX27L4000

When the MX27L4000 is delivered, or it is erased, the chip has all 4M bits in the "ONE" or HIGH state. "ZEROs" are loaded into the MX27L4000 through the procedure of programming.

For programming, the data to be programmed is applied with 8 bits in parallel to the data pins.

VCC must be applied simultaneously or before VPP, and removed simultaneously or after VPP. When programming an MXIC EPROM, a 0.1uF capacitor is required across Vpp and ground to suppress spurious voltage transients which may damage the device.

FAST PROGRAMMING

The device is set up in the fast programming mode when the programming voltage VPP = 12.75V is applied, with VCC = 6.25 V and \overline{OE} = VIH (Algorithm is shown in Figure 1). The programming is achieved by applying a single TTL low level 100us pulse to the \overline{CE} input after addresses and data line are stable. If the data is not verified, an additional pulse is applied for a maximum of 25 pulses. This process is repeated while sequencing through each address of the device. When the programming mode is completed, the data in all address is verified at VCC = VPP = 5V \pm 10%.

PROGRAM INHIBIT MODE

Programming of multiple MX27L4000s in parallel with different data is also easily accomplished by using the Program Inhibit Mode. Except for \overline{CE} and \overline{OE} , all like inputs of the parallel MX27L4000 may be common. A \overline{TTL} low-level program pulse applied to an $\underline{MX27L4000}$ \overline{CE} input with VPP = 12.5 ± 0.5 V and \overline{CE} LOW will program that $\underline{MX27L4000}$. A high-level \overline{CE} input inhibits the other $\underline{MX27L4000}$ s from being programmed.

PROGRAM VERIFY MODE

Verification should be performed on the programmed bits to determine that they were correctly <u>programmed</u>. The verification should be performed with \overline{OE} and \overline{CE} at VIL, and VPP at its programming voltage.

AUTO IDENTIFY MODE

The auto identify mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and device type. This mode is intended for use by programming equipment for the purpose of automatically matching the device to be programmed with its corresponding programming algorithm. This mode is functional in the 25 °C ± 5 °C ambient temperature range that is required when programming the MX27L4000.

To activate this mode, the programming equipment must force $12.0 \pm 0.5 \, \text{V}$ on address line A9 of the device. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from VIL to VIH. All other address lines must be held at VIL during auto identify mode.

Byte 0 (A0 = VIL) represents the manufacturer code, and byte 1 (A0 = VIH), the device identifier code. For the MX27L4000, these two identifier bytes are given in the Mode Select Table. All identifiers for manufacturer and device codes will possess odd parity, with the MSB (Q7) defined as the parity bit.

READ MODE

The MX27L4000 has two control functions, both of which must be logically satisfied in order to obtain data at the outputs. Chip Enable ($\overline{\text{CE}}$) is the power control and should be used for device selection. Output Enable ($\overline{\text{OE}}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (tACC) is equal to the delay from $\overline{\text{CE}}$ to output (tCE). Data is available at the outputs tOE after the falling edge of $\overline{\text{OE}}$'s, assuming that $\overline{\text{CE}}$ has been LOW and addresses have been stable for at least tACC - tOE.

STANDBY MODE

The MX27L4000 has a CMOS standby mode which reduces the maximum VCC current to 50 uA. It is placed in CMOS standby when \overline{CE} is at VCC \pm 0.3 V. The MX27L4000 also has a TTL-standby mode which reduces the maximum VCC current to 0.25 mA. It is placed in TTL-standby when \overline{CE} is at VIH. When in standby mode, the outputs are in a high-impedance state, independent of the \overline{OE} input.



TWO-LINE OUTPUT CONTROL FUNCTION

To accommodate multiple memory connections, a twoline control function is provided to allow for:

- 1. Low memory power dissipation,
- 2. Assurance that output bus contention will not occur.

It is recommended that \overline{CE} be decoded and used as the primary device-selecting function, while \overline{OE} be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low-power standby mode and that the output pins are only active when data is desired from a particular memory device.

SYSTEM CONSIDERATIONS

During the switch between active and standby conditions, transient current peaks are produced on the rising and falling edges of Chip Enable. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. At a minimum, a 0.1 uF ceramic capacitor (high frequency, low inherent inductance) should be used on each device between VCC and GND to minimize transient effects. In addition, to overcome the voltage drop caused by the inductive effects of the printed circuit board traces on EPROM arrays, a 4.7 uF bulk electrolytic capacitor should be used between VCC and GND for each eight devices. The location of the capacitor should be close to where the power supply is connected to the array.

MODE SELECT TABLE

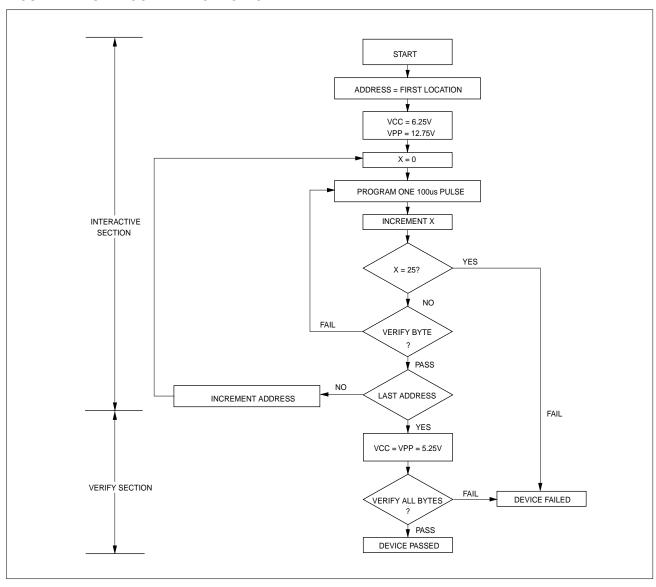
				PINS		
MODE	CE	OE	Α0	A9	VPP	OUTPUTS
Read	VIL	VIL	Х	Х	VCC	DOUT
Output Disable	VIL	VIH	Х	Х	VCC	High Z
Standby (TTL)	VIH	Х	Х	Х	VCC	High Z
Standby (CMOS)	VCC±0.3V	Х	Х	Х	VCC	High Z
Program	VIL	VIH	Х	Х	VPP	DIN
Program Verify	VIH	VIL	Х	Х	VPP	DOUT
Program Inhibit	VIH	VIH	Х	Х	VPP	High Z
Manufacturer Code(3)	VIL	VIL	VIL	VH	VCC	C2H
Device Code(3)	VIL	VIL	VIH	VH	VCC	40H

NOTES:

- 1. $VH = 12.0 V \pm 0.5 V$
- 2. X = Either VIH or VIL
- 3. A1 A8 = A10 A18 = VIL(For auto select)
- 4. See DC Programming Characteristics for VPP voltage during programming.

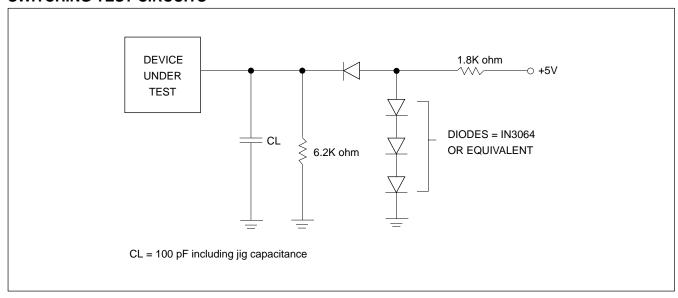


FIGURE 1. FAST PROGRAMMING FLOW CHART

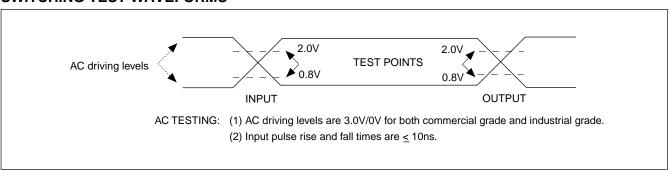




SWITCHING TEST CIRCUITS



SWITCHING TEST WAVEFORMS



P/N: PM00255 REV. 2.5, AUG. 20, 2001



ABSOLUTE MAXIMUM RATINGS

RATING	VALUE	
Ambient Operating Temperature -40°C to 85°C		
Storage Temperature	-65°C to 125°C	
Applied Input Voltage	-0.5V to 7.0V	
Applied Output Voltage	-0.5V to VCC+0.5V	
VCC to Ground Potential	-0.5V to 7.0V	
V9 & VPP	-0.5V to 13.5V	

NOTICE:

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended period may affect reliability.

NOTICE

Specifications contained within the following tables are subject to change.

DC/AC Operating Conditions for Read Operation

		MX27L4000			
		-20	-25		
Operating Temperature	Commercial	0℃ to 70℃	0℃ to 70℃		
	Industrial	-40℃ to 85℃	-40℃ to 85℃		
VCC Power Supply		2.7V to 3.6V	2.7V to 3.6V		

DC CHARACTERISTICS

SYMBOL	PARAMETER	MIN.	MAX.	UNIT	CONDITIONS
VOH	Output High Voltage	VCC-0.3		V	IOH = -100uA, VCC = 3.0V
VOL	Output Low Voltage		0.3	V	IOL = 2.1mA,VCC = 3.0V
VIH	Input High Voltage	2.0	VCC+0.5	V	
VIL	Input Low Voltage	-0.3	0.6	V	
ILI	Input Leakage Current	-10	10	uA	VIN = 0 to 3.6V
ILO	Output Leakage Current	-10	10	uA	VOUT = 0 to 3.6V
ICC3	VCC Power-Down Current		50	uA	CE = VCC ± 0.3V
ICC2	VCC Standby Current		0.25	mA	CE = VIH
ICC1	VCC Active Current		20	mA	CE = VIL, f=5MHz, lout = 0mA,
					VCC =3.6V
IPP	VPP Supply Current Read		10	uA	CE = OE = VIL, VPP = VCC

CAPACITANCE TA = 25° C, f = 1.0 MHz (Sampled only)

SYMBOL	PARAMETER	TYP.	MAX.	UNIT	CONDITIONS
CIN	Input Capacitance	8	12	pF	VIN = 0V
COUT	Output Capacitance	8	12	pF	VOUT = 0V
CVPP	VPP Capacitance	18	25	pF	VPP = 0V



AC CHARACTERISTICS

		27L4000-20		27L4000-25			
SYMBOL	_ PARAMETER	MIN.	MAX.	MIN.	MAX.	UNIT	CONDITIONS
tACC	Address to Output Delay		200		250	ns	$\overline{CE} = \overline{OE} = VIL$
tCE	Chip Enable to Output Delay		200		250	ns	OE = VIL
tOE	Output Enable to Output Delay		100		120	ns	CE = VIL
tDF	OE High to Output Float,	0	60	0	70	ns	
	or \overline{CE} High to Output Float						
tOH	Output Hold from Address,	0		0		ns	
	CE or OE which ever occurred first	st					

DC PROGRAMMING CHARACTERISTICS $TA = 25^{\circ}C \pm 5^{\circ}C$

SYMBOL	PARAMETER	MIN.	MAX.	UNIT	CONDITIONS
VOH	Output High Voltage	2.4		V	IOH = -0.40mA
VOL	Output Low Voltage		0.4	V	IOL = 2.1mA
VIH	Input High Voltage	2.0	VCC + 0.5	V	
VIL	Input Low Voltage	-0.3	0.8	V	
ILI	Input Leakage Current	-10	10	uA	VIN = 0 to 3.6V
VH	A9 Auto Select Voltage	11.5	12.5	V	
ICC3	VCC Supply Current (Program & Verify)		50	mA	
IPP2	VPP Supply Current(Program)		30	mA	$\overline{CE} = VIL, \overline{OE} = VIH$
VCC1	Fast Programming Supply Voltage	6.00	6.50	V	
VPP1	Fast Programming Voltage	12.5	13.0	V	

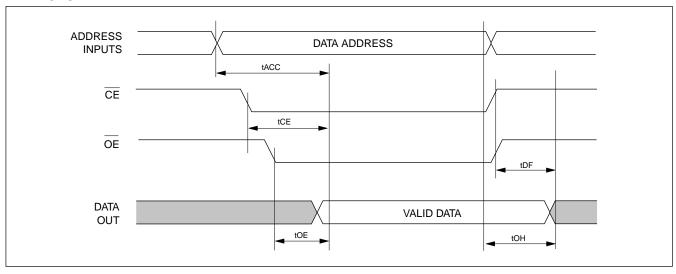
AC PROGRAMMING CHARACTERISTICS TA = 25° C $\pm 5^{\circ}$ C

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
tAS	Address Setup Time	2.0		us
tOES	OE Setup Time	2.0		us
tDS	Data Setup Time	2.0		us
tAH	Address Hold Time	0		us
tDH	Data Hold Time	2.0		us
tDFP	Output Enable to Output Float Delay	0	130	ns
tVPS	VPP Setup Time	2.0		us
tPW	PGM Program Pulse Width	95	105	us
tVCS	VCC Setup Time	2.0		us
tOE	Data valid from OE		150	ns

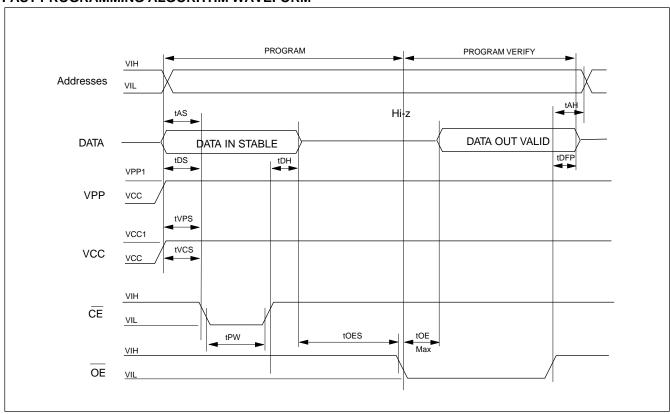


WAVEFORMS

READ CYCLE



FAST PROGRAMMING ALGORITHM WAVEFORM





ORDERING INFORMATION

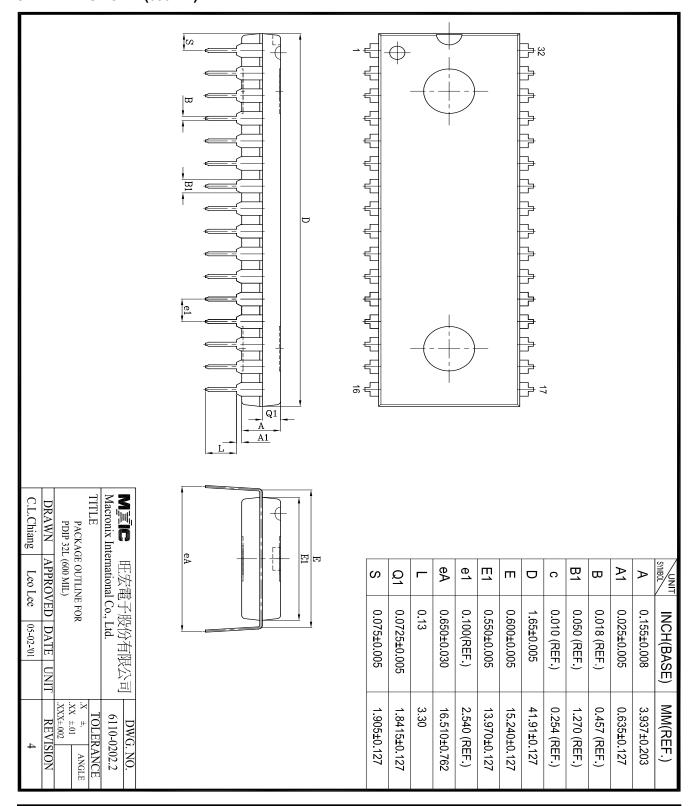
PLASTIC PACKAGE

PART NO.	ACCESS TIME(ns)	OPERATING	STANDBY	OPERATING	PACKAGE
	C	URRENT MAX.(mA)	CURRENT MAX.(uA)	TEMPERATUR	E
MX27L4000PC-2	250	20	50	0℃ to 70℃	32 Pin DIP
MX27L4000PC-2	200	20	50	0℃ to 70℃	32 Pin DIP
MX27L4000QC-2	25 250	20	50	0℃ to 70℃	32 Pin PLCC
MX27L4000QC-2	20 200	20	50	0℃ to 70℃	32 Pin PLCC
MX27L4000MC-2	25 250	20	50	0℃ to 70℃	32 Pin SOP
MX27L4000MC-2	20 200	20	50	0℃ to 70℃	32 Pin SOP
MX27L4000TC-2	5 250	20	50	0℃ to 70℃	32 Pin TSOP
MX27L4000TC-2	0 200	20	50	0℃ to 70℃	32 Pin TSOP
MX27L4000PI-25	5 250	20	50	-40℃ to 85℃	32 Pin DIP
MX27L4000PI-20	200	20	50	-40℃ to 85℃	32 Pin DIP
MX27L4000QI-25	5 250	20	50	-40℃ to 85℃	32 Pin PLCC
MX27L4000QI-20	200	20	50	-40℃ to 85℃	32 Pin PLCC
MX27L4000MI-2	5 250	20	50	-40℃ to 85℃	32 Pin SOP
MX27L4000MI-20	0 200	20	50	-40℃ to 85℃	32 Pin SOP
MX27L4000TI-25	5 250	20	50	-40℃ to 85℃	32 Pin TSOP
MX27L4000TI-20	200	20	50	-40℃ to 85℃	32 Pin TSOP



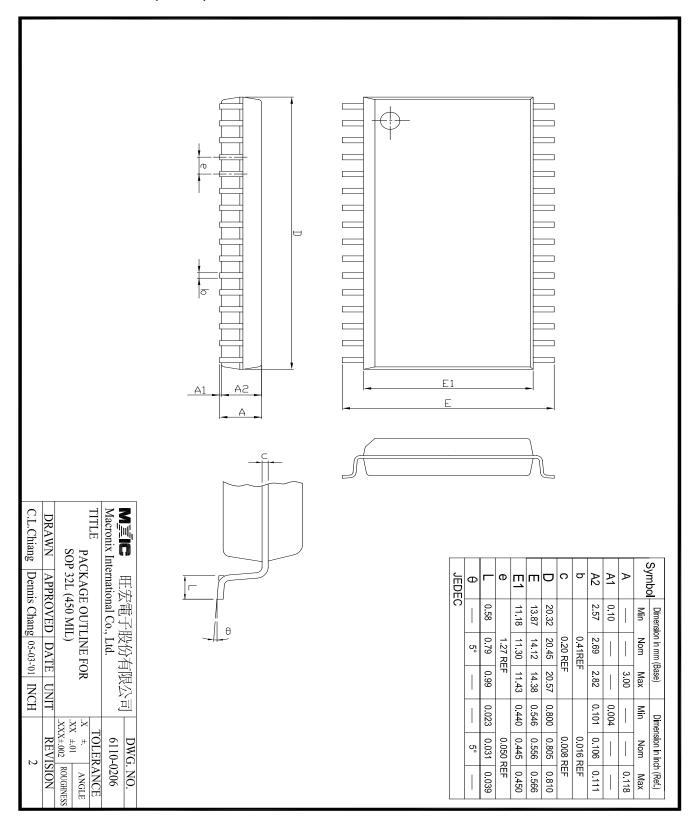
PACKAGE INFORMATION

32-PIN PLASTIC DIP(600 mil)



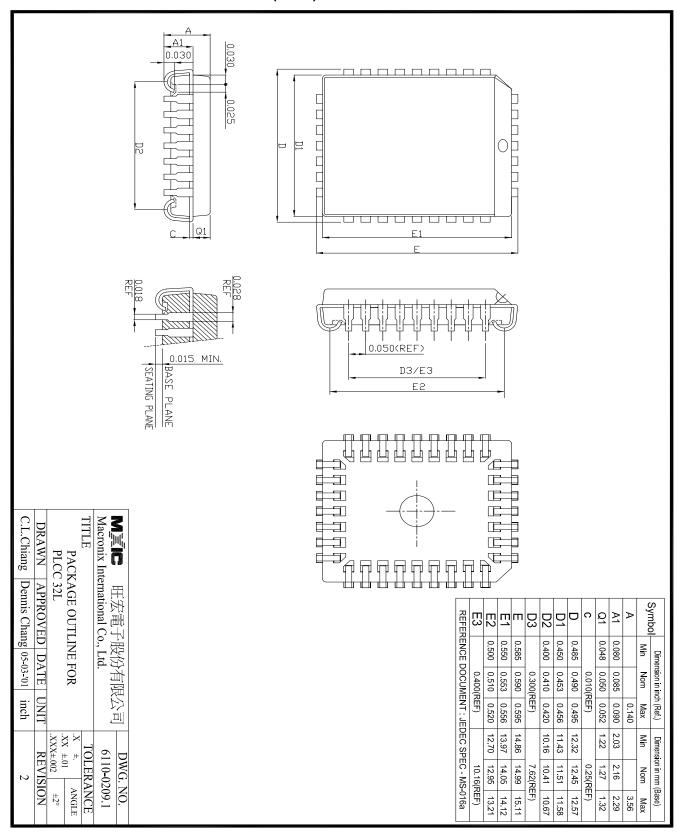


32-PIN PLASTIC SOP (450 mil)



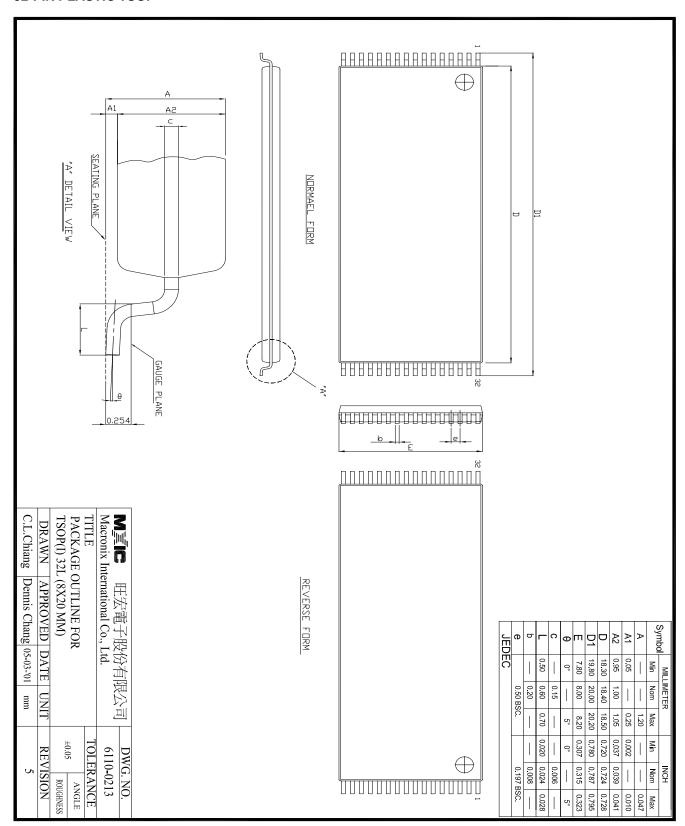


32-PIN PLASTIC LEADED CHIP CARRIER (PLCC)





32-PIN PLASTIC TSOP







REVISION HISTORY

Revision No.	Description	Page	Date
2.0	1) AC driving levels changed from 2.4V/0.3V to 3.0V/0V.		6/05/1997
	2) Change package type, from 12 x 20 mm 48TSOP(I) to		
	8 x 20mm 32TSOP(I)		
	3) Eliminate Interactive Programming Mode.		
2.1	IPP1 100uA> 10uA		7/17/1997
2.2	Change TSOP Orientation		4/09/1998
2.3	Cancel Ceramic DIP package type	P1,2,9,10	MAR/02/2000
2.4	To modify Package Information	P10~13	JUL/19/2001
2.5	Cancel "Ultraviolet Erasable" wording in General Description	P1	AUG/20/2001

P/N: PM00255 REV. 2.5, AUG. 20, 2001



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